

Synchronous Presettable Binary Counter

MC74AC161, MC74ACT161, MC74AC163, MC74ACT163

The MC74AC161/74ACT161 and MC74AC163/74ACT163 are high-speed synchronous modulo-16 binary counters. They are synchronously presettable for application in programmable dividers and have two types of Count Enable inputs plus a Terminal Count output for versatility in forming synchronous multistage counters.

The MC74AC161/74ACT161 has an asynchronous Master Reset input that overrides all other inputs and forces the outputs LOW. The MC74AC163/74ACT163 has a Synchronous Reset input that overrides counting and parallel loading and allows the outputs to be simultaneously reset on the rising edge of the clock.

Features

- Synchronous Counting and Loading
- High-Speed Synchronous Expansion
- Typical Count Rate of 125 MHz
- Outputs Source/Sink 24 mA
- 'ACT161 and 'ACT163 Have TTL Compatible Inputs
- These are Pb-Free Devices

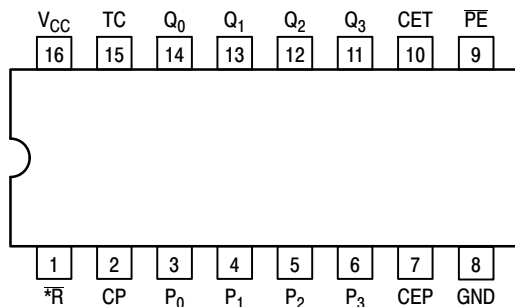
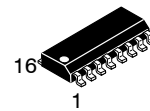


Figure 1. Pinout: 16-Lead Packages Conductors
(Top View)

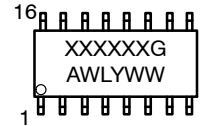
PIN ASSIGNMENT

PIN	FUNCTION
CEP	Count Enable Parallel Input
CET	Count Enable Trickle Input
CP	Clock Pulse Input
MR	('161) Asynchronous Master Reset Input
SR	('163) Synchronous Reset Input
P ₀ -P ₃	Parallel Data Inputs
PE	Parallel Enable Input
Q ₀ -Q ₃	Flip-Flop Outputs
TC	Terminal Count Output

MARKING DIAGRAM



SOIC-16
D SUFFIX
CASE 751B



XXX = Specific Device Code
A = Assembly Location
WL = Wafer Lot
Y = Year
WW = Work Week
G = Pb-Free Package

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 11 of this data sheet.

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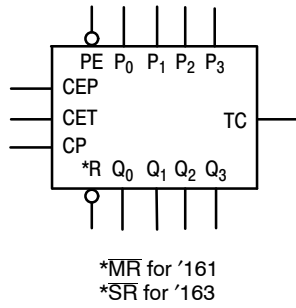


Figure 2. Logic Symbol

FUNCTIONAL DESCRIPTION

The MC74AC161/ACT161 and MC74AC163/ACT163 count modulo-16 binary sequence. From state 15 (HHHH) they increment to state 0 (LLLL). The clock inputs of all flip-flops are driven in parallel through a clock buffer. Thus all changes of the Q outputs (except due to Master Reset of the '161) occur as a result of, and synchronous with, the LOW-to-HIGH transition of the CP input signal. The circuits have four fundamental modes of operation, in order of precedence: asynchronous reset ('161), synchronous reset ('163), parallel load, count-up and hold. Five control inputs – Master Reset ($\overline{MR}$, '161), Synchronous Reset ($\overline{SR}$, '163), Parallel Enable ($\overline{PE}$), Count Enable Parallel (CEP) and Count Enable Trickle (CET) – determine the mode of

operation, as shown in the Mode Select Table. A LOW signal on $\overline{MR}$ overrides all other inputs and asynchronously forces all outputs LOW. A LOW signal on $\overline{SR}$ overrides counting and parallel loading and allows all outputs to go LOW on the next rising edge of CP. A LOW signal on $\overline{PE}$ overrides counting and allows information on the Parallel Data (P_n) inputs to be loaded into the flip-flops on the next rising edge of CP. With $\overline{PE}$ and $\overline{MR}$ ('161) or $\overline{SR}$ ('163) HIGH, CEP and CET permit counting when both are HIGH. Conversely, a LOW signal on either CEP or CET inhibits counting.

The MC74AC161/ACT161 and MC74AC163/ACT163 use D-type edge-triggered flip-flops and changing the $\overline{SR}$, $\overline{PE}$, CEP and CET inputs when the CP is in either state does not cause errors, provided that the recommended setup and hold times, with respect to the rising edge of CP, are observed.

The Terminal Count (TC) output is HIGH when CET is HIGH and counter is in state 15. To implement synchronous multistage counters, the TC outputs can be used with the CEP and CET inputs in two different ways. Please refer to the MC74AC568 data sheet. The TC output is subject to decoding spikes due to internal race conditions and is therefore not recommended for use as a clock or asynchronous reset for flip-flops, counters or registers.

Logic Equations:

$$\text{Count Enable} = \text{CEP} \cdot \text{CET} \cdot \overline{\text{PE}}$$

$$\text{TC} = Q_0 \cdot Q_1 \cdot Q_2 \cdot Q_3 \cdot \text{CET}$$

MODE SELECT TABLE

*SR	PE	CET	CEP	Action on the Rising Clock Edge ()
L	X	X	X	Reset (Clear)
H	L	X	X	Load ($P_n \rightarrow Q_n$)
H	H	H	H	Count (Increment)
H	H	L	X	No Change (Hold)
H	H	X	L	No Change (Hold)

*For '163 only

H = HIGH Voltage Level

L = LOW Voltage Level

X = Immaterial

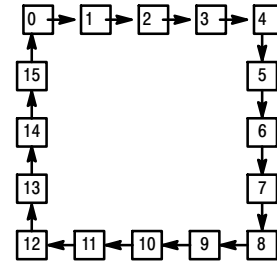
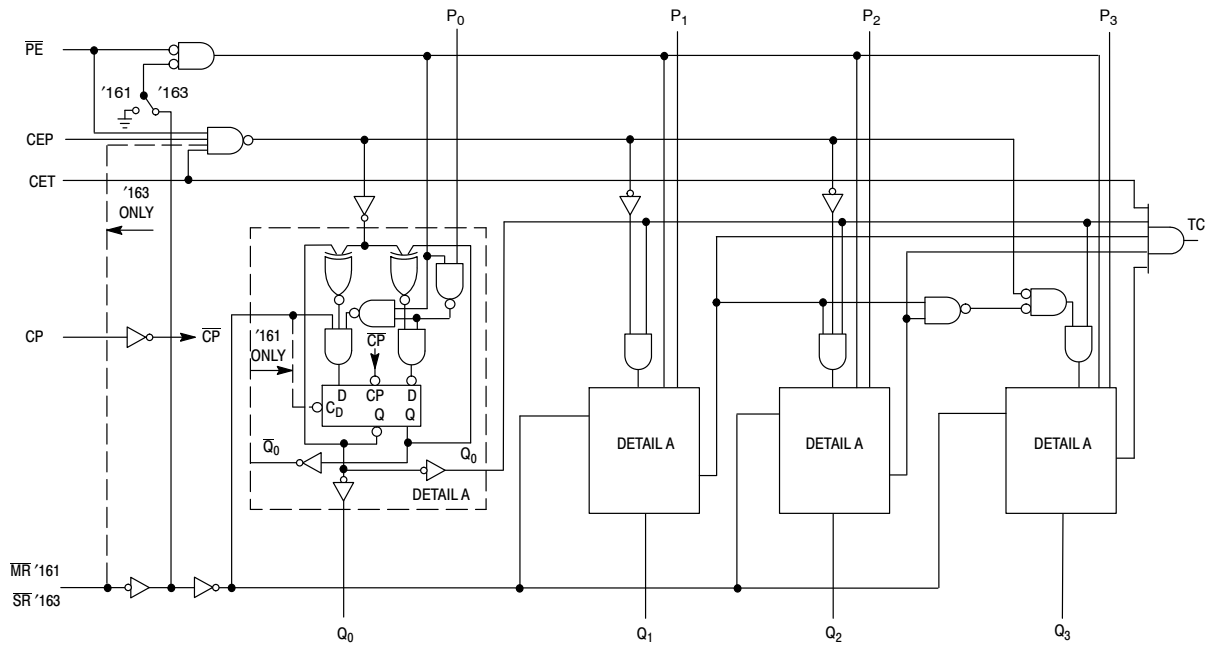


Figure 3. State Diagram

MC74AC161, MC74ACT161, MC74AC163, MC74ACT163



NOTE: This diagram is provided only for the understanding of logic operations and should not be used to estimate propagation delays.

Figure 4. Logic Diagram

MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V _{CC}	DC Supply Voltage	−0.5 to +6.5	V
V _I	DC Input Voltage	−0.5 ≤ V _I ≤ V _{CC} + 0.5	V
V _O	DC Output Voltage (Note 1)	−0.5 ≤ V _O ≤ V _{CC} + 0.5	V
I _{IK}	DC Input Diode Current	±20	mA
I _{OK}	DC Output Diode Current	±50	mA
I _O	DC Output Sink/Source Current	±50	mA
I _{CC}	DC Supply Current per Output Pin	±50	mA
I _{GND}	DC Ground Current per Output Pin	±50	mA
T _{STG}	Storage Temperature Range	−65 to +150	°C
T _L	Lead temperature, 1 mm from Case for 10 Seconds	260	°C
T _J	Junction temperature under Bias	+150	°C
θ _{JA}	Thermal Resistance (Note 2)	126	°C/W
P _D	Power Dissipation in Still Air at 25°C (Note 3)	995	mW
MSL	Moisture Sensitivity	Level 1	
F _R	Flammability Rating Oxygen Index: 30% – 35%	UL 94 V-0 @ 0.125 in	
V _{ESD}	ESD Withstand Voltage Human Body Model (Note 4) Charged Device Model (Note 5)	> 2000 > 1000	V
I _{Latch-Up}	Latch-Up Performance Above V _{CC} and Below GND at 85°C (Note 6)	±100	mA

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. I_O absolute maximum rating must be observed.
2. The package thermal impedance is calculated in accordance with JESD51-7.
3. 500 mW at 65°C; derate to 300 mW by 10 mW/ from 65°C to 85°C.
4. Tested to EIA/JESD22-A114-A.
5. Tested to JESD22-C101-A.
6. Tested to EIA/JESD78.

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RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Min	Typ	Max	Unit
V _{CC}	Supply Voltage	'AC	2.0	5.0	V
		'ACT	4.5	5.0	
V _{IN} , V _{OUT}	DC Input Voltage, Output Voltage (Ref. to GND)	0	–	V _{CC}	V
t _r , t _f	Input Rise and Fall Time (Note 1) 'AC Devices except Schmitt Inputs	V _{CC} @ 3.0 V	–	150	ns/V
		V _{CC} @ 4.5 V	–	40	
		V _{CC} @ 5.5 V	–	25	
t _r , t _f	Input Rise and Fall Time (Note 2) 'ACT Devices except Schmitt Inputs	V _{CC} @ 4.5 V	–	10	ns/V
		V _{CC} @ 5.5 V	–	8.0	
T _A	Operating Ambient Temperature Range	–40	25	85	°C
I _{OH}	Output Current – High	–	–	–24	mA
I _{OL}	Output Current – Low	–	–	24	mA

1. V_{IN} from 30% to 70% V_{CC}; see individual Data Sheets for devices that differ from the typical input rise and fall times.

2. V_{IN} from 0.8 V to 2.0 V; see individual Data Sheets for devices that differ from the typical input rise and fall times.

DC CHARACTERISTICS

Symbol	Parameter	V _{CC} (V)	74AC		74AC	Unit	Conditions
			T _A = +25°C		T _A = –40°C to +85°C		
			Typ	Guaranteed Limits			
V _{IH}	Minimum High Level Input Voltage	3.0	1.5	2.1	2.1	V	V _{OUT} = 0.1 V or V _{CC} – 0.1 V
		4.5	2.25	3.15	3.15		
		5.5	2.75	3.85	3.85		
V _{IL}	Maximum Low Level Input Voltage	3.0	1.5	0.9	0.9	V	V _{OUT} = 0.1 V or V _{CC} – 0.1 V
		4.5	2.25	1.35	1.35		
		5.5	2.75	1.65	1.65		
V _{OH}	Minimum High Level Output Voltage	3.0	2.99	2.9	2.9	V	I _{OUT} = –50 μA
		4.5	4.49	4.4	4.4		
		5.5	5.49	5.4	5.4		
		3.0	–	2.56	2.46	V	*V _{IN} = V _{IL} or V _{IH} –12 mA I _{OH} –24 mA –24 mA
		4.5	–	3.86	3.76		
		5.5	–	4.86	4.76		
V _{OL}	Maximum Low Level Output Voltage	3.0	0.002	0.1	0.1	V	I _{OUT} = 50 μA
		4.5	0.001	0.1	0.1		
		5.5	0.001	0.1	0.1		
		3.0	–	0.36	0.44	V	*V _{IN} = V _{IL} or V _{IH} 12 mA I _{OL} 24 mA 24 mA
		4.5	–	0.36	0.44		
		5.5	–	0.36	0.44		
I _{IN}	Maximum Input Leakage Current	5.5	–	±0.1	±1.0	μA	V _I = V _{CC} , GND
I _{OLD}	†Minimum Dynamic Output Current	5.5	–	–	75	mA	V _{OLD} = 1.65 V Max
I _{OHD}		5.5	–	–	–75	mA	V _{OHD} = 3.85 V Min
I _{CC}	Maximum Quiescent Supply Current	5.5	–	8.0	80	μA	V _{IN} = V _{CC} or GND

*All outputs loaded; thresholds on input associated with output under test.

†Maximum test duration 2.0 ms, one output loaded at a time.

NOTE: I_{IN} and I_{CC} @ 3.0 V are guaranteed to be less than or equal to the respective limit @ 5.5 V V_{CC}.

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AC CHARACTERISTICS

Symbol	Parameter	V _{CC} * (V)	74AC161			74AC161		Unit
			T _A = +25°C C _L = 50 pF			T _A = -40°C to +85°C C _L = 50 pF		
			Min	Typ	Max	Min	Max	
f _{max}	Maximum Count Frequency	3.3 5.0	70 110	111 167	– –	60 95	– –	MHz
t _{PLH}	Propagation Delay CP to Q _n (PE Input HIGH or LOW)	3.3 5.0	2.0 1.5	7.0 5.0	12.0 9.0	1.5 1.0	13.5 9.5	ns
t _{PHL}	Propagation Delay CP to Q _n (PE Input HIGH or LOW)	3.3 5.0	1.5 1.5	7.0 5.0	12.0 9.5	1.5 1.5	13.0 10.0	ns
t _{PLH}	Propagation Delay CP to TC	3.3 5.0	3.0 2.0	9.0 6.0	15.0 10.5	2.5 1.5	16.5 11.5	ns
t _{PHL}	Propagation Delay CP to TC	3.3 5.0	3.5 2.0	8.5 6.5	14.0 11.0	2.5 2.0	15.5 11.5	ns
t _{PLH}	Propagation Delay CET to TC	3.3 5.0	2.0 1.5	5.5 3.5	9.5 6.5	1.5 1.0	11.0 7.5	ns
t _{PHL}	Propagation Delay CET to TC	3.3 5.0	2.5 2.0	6.5 5.0	11.0 8.5	2.0 1.5	12.5 9.5	ns
t _{PHL}	Propagation Delay MR to Q _n	3.3 5.0	2.0 1.5	6.0 5.5	12.0 9.5	1.5 1.5	13.5 10.0	ns
t _{PHL}	Propagation Delay MR to TC	3.3 5.0	3.5 2.5	10.0 8.5	15.0 13.0	3.0 2.5	17.5 13.5	ns

*Voltage Range 3.3 V is 3.3 V ±0.3 V.

*Voltage Range 5.0 V is 5.0 V ±0.5 V.

AC CHARACTERISTICS

Symbol	Parameter	V _{CC} * (V)	74AC163			74AC163		Unit
			T _A = +25°C C _L = 50 pF			T _A = -40°C to +85°C C _L = 50 pF		
			Min	Typ	Max	Min	Max	
f _{max}	Maximum Count Frequency	3.3 5.0	70 110	95 140	– –	60 95	– –	MHz
t _{PLH}	Propagation Delay CP to Q _n (PE Input HIGH or LOW)	3.3 5.0	2.0 1.5	7.5 5.5	12.5 9.0	1.5 1.0	13.5 9.5	ns
t _{PHL}	Propagation Delay CP to Q _n (PE Input HIGH or LOW)	3.3 5.0	1.5 1.5	8.5 6.0	12.0 9.5	1.5 1.5	13.0 10.0	ns
t _{PLH}	Propagation Delay CP to TC	3.3 5.0	3.0 2.0	9.5 7.0	15.0 10.5	2.5 1.5	16.5 11.5	ns
t _{PHL}	Propagation Delay CP to TC	3.3 5.0	3.5 2.0	11.0 8.0	14.0 11.0	2.5 2.0	15.5 11.5	ns
t _{PLH}	Propagation Delay CET to TC	3.3 5.0	2.0 1.5	7.5 5.5	9.5 6.5	1.5 1.0	11.0 7.5	ns
t _{PHL}	Propagation Delay CET to TC	3.3 5.0	2.5 2.0	8.5 6.0	11.0 8.5	2.0 1.5	12.5 9.5	ns

*Voltage Range 3.3 V is 3.3 V ±0.3 V.

*Voltage Range 5.0 V is 5.0 V ±0.5 V.

MC74AC161, MC74ACT161, MC74AC163, MC74ACT163

AC OPERATING REQUIREMENTS

Symbol	Parameter	V _{CC} * (V)	74AC161		74AC161	Unit
			T _A = +25°C C _L = 50 pF		T _A = -40°C to +85°C C _L = 50 pF	
			Typ	Guaranteed Minimum		
t _s	Setup Time, HIGH or LOW P _n to CP	3.3	6.0	13.5	16.0	ns
		5.0	3.5	8.5	10.5	
t _h	Hold Time, HIGH or LOW P _n to CP	3.3	-7.0	-1.0	-0.5	ns
		5.0	-4.0	0	0	
t _s	Setup Time, HIGH or LOW PE to CP	3.3	6.5	11.5	14.0	ns
		5.0	4.0	7.5	8.5	
t _h	Hold Time, HIGH or LOW PE to CP	3.3	-6.0	0	0	ns
		5.0	-3.5	0.5	1.0	
t _s	Setup Time, HIGH or LOW CEP or CET to CP	3.3	3.0	6.0	7.0	ns
		5.0	2.0	4.5	5.0	
t _h	Hold Time, HIGH or LOW CEP or CET to CP	3.3	-3.5	0	0	ns
		5.0	-2.0	0	0.5	
t _w	Clock Pulse Width (Load) HIGH or LOW	3.3	2.0	3.5	4.0	ns
		5.0	2.0	2.5	3.0	
t _w	Clock Pulse Width (Count) HIGH or LOW	3.3	2.0	4.0	4.5	ns
		5.0	2.0	3.0	3.5	
t _w	MR Pulse Width, LOW	3.3	3.0	5.5	7.5	ns
		5.0	2.5	4.5	6.0	
t _{rec}	Recovery Time MR to CP	3.3	-2.0	-0.5	0	ns
		5.0	-1.0	0	0.5	

*Voltage Range 3.3 V is 3.3 V ±0.3 V.

*Voltage Range 5.0 V is 5.0 V ±0.5 V.

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AC OPERATING REQUIREMENTS

Symbol	Parameter	V _{CC} * (V)	74AC163		74AC163	Unit
			T _A = +25°C C _L = 50 pF		T _A = -40°C to +85°C C _L = 50 pF	
			Typ	Guaranteed Minimum		
t _s	Setup Time, HIGH or LOW P _n to CP	3.3	5.5	13.5	16.0	ns
		5.0	4.0	8.5	10.5	
t _h	Hold Time, HIGH or LOW P _n to CP	3.3	-7.0	-1.0	-0.5	ns
		5.0	-5.0	0	0	
t _s	Setup Time, HIGH or LOW SR to CP	3.3	5.5	14	16.5	ns
		5.0	4.0	9.5	11.0	
t _h	Hold Time, HIGH or LOW SR to CP	3.3	-7.5	-1.0	-0.5	ns
		5.0	-5.5	-0.5	0	
t _s	Setup Time, HIGH or LOW PE to CP	3.3	5.5	11.5	14.0	ns
		5.0	4.0	7.5	8.5	
t _h	Hold Time, HIGH or LOW PE to CP	3.3	-7.5	-1.0	-0.5	ns
		5.0	-5.0	-0.5	0	
t _s	Setup Time, HIGH or LOW CEP or CET to CP	3.3	3.5	6.0	7.0	ns
		5.0	2.5	4.5	5.0	
t _h	Hold Time, HIGH or LOW CEP or CET to CP	3.3	-4.5	0	0	ns
		5.0	-3.0	0	0.5	
t _w	Clock Pulse Width (Load) HIGH or LOW	3.3	3.0	3.5	4.0	ns
		5.0	2.0	2.5	3.0	
t _w	Clock Pulse Width (Count) HIGH or LOW	3.3	3.0	4.0	4.5	ns
		5.0	2.0	3.0	3.5	

*Voltage Range 3.3 V is 3.3 V ±0.3 V.

*Voltage Range 5.0 V is 5.0 V ±0.5 V.

MC74AC161, MC74ACT161, MC74AC163, MC74ACT163

DC CHARACTERISTICS

Symbol	Parameter	V _{CC} (V)	74ACT		74ACT	Unit	Conditions
			T _A = +25°C		T _A = –40°C to +85°C		
			Typ	Guaranteed Limits			
V _{IH}	Minimum High Level Input Voltage	4.5 5.5	1.5 1.5	2.0 2.0	2.0 2.0	V	V _{OUT} = 0.1 V or V _{CC} – 0.1 V
V _{IL}	Maximum Low Level Input Voltage	4.5 5.5	1.5 1.5	0.8 0.8	0.8 0.8	V	V _{OUT} = 0.1 V or V _{CC} – 0.1 V
V _{OH}	Minimum High Level Output Voltage	4.5 5.5	4.49 5.49	4.4 5.4	4.4 5.4	V	I _{OUT} = –50 μA
		4.5 5.5	– –	3.86 4.86	3.76 4.76	V	*V _{IN} = V _{IL} or V _{IH} –24 mA I _{OH} –24 mA
V _{OL}	Maximum Low Level Output Voltage	4.5 5.5	0.001 0.001	0.1 0.1	0.1 0.1	V	I _{OUT} = 50 μA
		4.5 5.5	– –	0.36 0.36	0.44 0.44	V	*V _{IN} = V _{IL} or V _{IH} 24 mA I _{OL} 24 mA
I _{IN}	Maximum Input Leakage Current	5.5	–	±0.1	±1.0	μA	V _I = V _{CC} , GND
ΔI _{CCT}	Additional Max. I _{CC} /Input	5.5	0.6	–	1.5	mA	V _I = V _{CC} – 2.1 V
I _{OLD}	†Minimum Dynamic Output Current	5.5	–	–	75	mA	V _{OLD} = 1.65 V Max
I _{OHD}		5.5	–	–	–75	mA	V _{OHD} = 3.85 V Min
I _{CC}	Maximum Quiescent Supply Current	5.5	–	8.0	80	μA	V _{IN} = V _{CC} or GND

*All outputs loaded; thresholds on input associated with output under test.

†Maximum test duration 2.0 ms, one output loaded at a time.

MC74AC161, MC74ACT161, MC74AC163, MC74ACT163

AC CHARACTERISTICS

Symbol	Parameter	V _{CC} * (V)	74ACT161			74ACT161		Unit
			T _A = +25°C C _L = 50 pF			T _A = -40°C to +85°C C _L = 50 pF		
			Min	Typ	Max	Min	Max	
f _{max}	Maximum Count Frequency	5.0	115	125	–	100	–	MHz
t _{PLH}	Propagation Delay CP to Q _n (PE Input HIGH or LOW)	5.0	1.5	8.0	9.5	1.5	10.5	ns
t _{PHL}	Propagation Delay CP or Q _n (PE Input HIGH or LOW)	5.0	1.5	8.0	10.5	1.5	11.5	ns
t _{PLH}	Propagation Delay CP to TC	5.0	2.0	11.0	11.0	1.5	12.5	ns
t _{PHL}	Propagation Delay CP to TC	5.0	1.5	11.0	12.5	1.5	13.5	ns
t _{PLH}	Propagation Delay CET to TC	5.0	1.5	7.5	8.5	1.5	10.0	ns
t _{PHL}	Propagation Delay CET to TC	5.0	1.5	8.0	9.5	1.5	10.5	ns
t _{PHL}	Propagation Delay MR to Q _n	5.0	1.5	8.0	10.0	1.5	11.0	ns
t _{PHL}	Propagation Delay MR to TC	5.0	2.5	10.0	13.5	2.0	14.5	ns

*Voltage Range 5.0 V is 5.0 V ±0.5 V.

AC CHARACTERISTICS

Symbol	Parameter	V _{CC} * (V)	74ACT163			74ACT163		Unit
			T _A = +25°C C _L = 50 pF			T _A = −40°C to +85°C C _L = 50 pF		
			Min	Typ	Max	Min	Max	
f _{max}	Maximum Count Frequency	5.0	120	140	–	105	–	MHz
t _{PLH}	Propagation Delay CP to Q _n (PE Input HIGH or LOW)	5.0	1.5	5.5	10.0	1.5	11.0	ns
t _{PHL}	Propagation Delay CP to Q _n (PE Input HIGH or LOW)	5.0	1.5	6.0	11.0	1.5	12.0	ns
t _{PLH}	Propagation Delay CP to TC	5.0	2.5	7.0	11.5	2.0	13.5	ns
t _{PHL}	Propagation Delay CP to TC	5.0	3.0	8.0	13.5	2.0	15.0	ns
t _{PLH}	Propagation Delay CET to TC	5.0	2.0	5.5	9.0	1.5	10.5	ns
t _{PHL}	Propagation Delay CET to TC	5.0	2.0	6.0	10.0	2.0	11.0	ns

*Voltage Range 5.0 V is 5.0 V ±0.5 V.

MC74AC161, MC74ACT161, MC74AC163, MC74ACT163

AC OPERATING REQUIREMENTS

Symbol	Parameter	V _{CC} * (V)	74ACT161		74ACT161	Unit
			T _A = +25°C C _L = 50 pF		T _A = -40°C to +85°C C _L = 50 pF	
			Typ	Guaranteed Minimum		
t _s	Setup Time, HIGH or LOW P _n to CP	5.0	7.0	9.5	11.5	ns
t _h	Hold Time, HIGH or LOW P _n to CP	5.0	-3.0	0	0	ns
t _s	Setup Time, HIGH or LOW PE to CP	5.0	6.0	8.5	9.5	ns
t _h	Hold Time, HIGH or LOW PE to CP	5.0	-3.5	- 0.5	- 0.5	ns
t _s	Setup Time, HIGH or LOW CEP or CET to CP	5.0	4.0	5.5	6.5	ns
t _h	Hold Time, HIGH or LOW CEP or CET to CP	5.0	-2.0	0	0	ns
t _w	Clock Pulse Width (Load) HIGH or LOW	5.0	2.0	3.0	3.5	ns
t _w	Clock Pulse Width (Count) HIGH or LOW	5.0	2.0	3.0	3.5	ns
t _w	MR Pulse Width, LOW	5.0	3.0	3.0	7.5	ns
t _{rec}	Recovery Time MR to CP	5.0	0	0	0.5	ns

*Voltage Range 5.0 V is 5.0 V ±0.5 V.

MC74AC161, MC74ACT161, MC74AC163, MC74ACT163

AC OPERATING REQUIREMENTS

Symbol	Parameter	V _{CC} * (V)	74ACT163		74ACT163	Unit
			T _A = +25°C C _L = 50 pF		T _A = -40°C to +85°C C _L = 50 pF	
			Typ	Guaranteed Minimum		
t _s	Setup Time, HIGH or LOW P _n to CP	5.0	4.0	10.0	12.0	ns
t _h	Hold Time, HIGH or LOW P _n to CP	5.0	-5.0	0.5	0.5	ns
t _s	Setup Time, HIGH or LOW SR to CP	5.0	4.0	10.0	11.5	ns
t _h	Hold Time, HIGH or LOW SR to CP	5.0	-5.5	-0.5	-0.5	ns
t _s	Setup Time, HIGH or LOW PE to CP	5.0	4.0	8.5	10.5	ns
t _h	Hold Time, HIGH or LOW PE to CP	5.0	-5.5	-0.5	0	ns
t _s	Setup Time, HIGH or LOW CEP or CET to CP	5.0	2.5	5.5	6.5	ns
t _h	Hold Time, HIGH or LOW CEP or CET to CP	5.0	-3.0	0	0.5	ns
t _w	Clock Pulse Width HIGH or LOW	5.0	2.0	3.5	3.5	ns
t _w	Clock Pulse Width (Count) HIGH or LOW	5.0	2.0	3.5	3.5	ns

*Voltage Range 5.0 V is 5.0 V ±0.5 V.

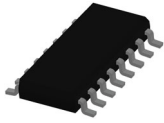
CAPACITANCE

Symbol	Parameter	Value Typ	Unit	Test Conditions
C _{IN}	Input Capacitance	4.5	pF	V _{CC} = 5.0 V
C _{PD}	Power Dissipation Capacitance	45	pF	V _{CC} = 5.0 V

ORDERING INFORMATION

Device	Package	Shipping†
MC74AC163DR2G	SOIC-16 (Pb-Free)	2500 / Tape & Reel
MC74ACT163DR2G		2500 / Tape & Reel

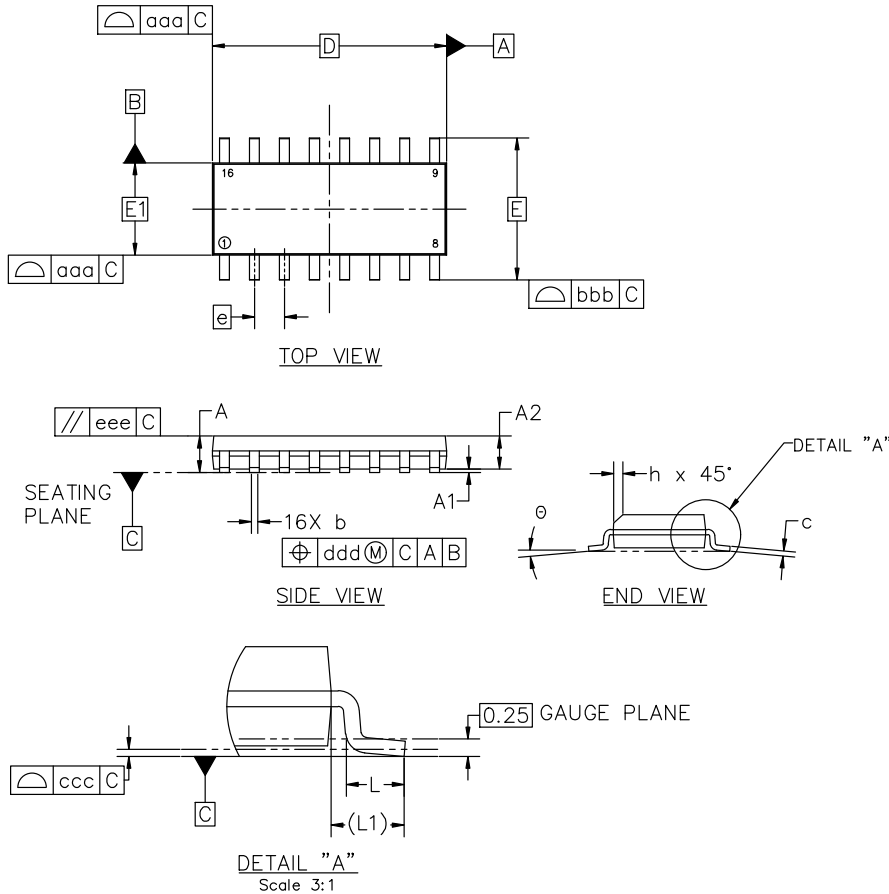
†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.


SOIC-16 9.90x3.90x1.37 1.27P
CASE 751B
ISSUE M

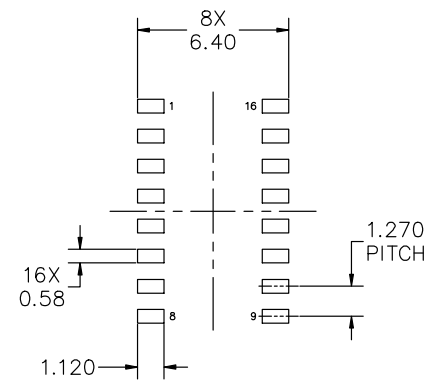
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NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2018.
2. DIMENSION IN MILLIMETERS. ANGLE IN DEGREES.
3. DIMENSIONS D AND E1 DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15mm PER SIDE.
5. DIMENSION b DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127mm TOTAL IN EXCESS OF THE b DIMENSION AT MAXIMUM MATERIAL CONDITION.



MILLIMETERS			
DIM	MIN	NOM	MAX
A	1.35	1.55	1.75
A1	0.10	0.18	0.25
A2	1.25	1.37	1.50
b	0.35	0.42	0.49
c	0.19	0.22	0.25
D	9.90 BSC		
E	6.00 BSC		
E1	3.90 BSC		
e	1.27 BSC		
h	0.25	---	0.50
L	0.40	0.83	1.25
L1	1.05 REF		
θ	0°	---	7°
TOLERANCE OF FORM AND POSITION			
aaa	0.10		
bbb	0.20		
ccc	0.10		
ddd	0.25		
eee	0.10		



*FOR ADDITIONAL INFORMATION ON OUR PB-FREE STRATEGY AND SOLDERING DETAILS, PLEASE DOWNLOAD THE onsemi SOLDERING AND MOUNTING TECHNIQUES REFERENCE MANUAL, SOLDERM/D

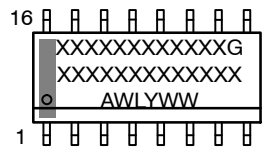
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SOIC-16 9.90x3.90x1.37 1.27P
CASE 751B
ISSUE M

DATE 18 OCT 2024

GENERIC
MARKING DIAGRAM*



XXXXX = Specific Device Code
A = Assembly Location
WL = Wafer Lot
Y = Year
WW = Work Week
G = Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "▪", may or may not be present. Some products may not follow the Generic Marking.

STYLE 1: PIN 1. COLLECTOR 2. BASE 3. EMITTER 4. NO CONNECTION 5. EMITTER 6. BASE 7. COLLECTOR 8. COLLECTOR 9. BASE 10. EMITTER 11. NO CONNECTION 12. EMITTER 13. BASE 14. COLLECTOR 15. EMITTER 16. COLLECTOR	STYLE 2: PIN 1. CATHODE 2. ANODE 3. NO CONNECTION 4. CATHODE 5. CATHODE 6. NO CONNECTION 7. ANODE 8. CATHODE 9. CATHODE 10. ANODE 11. NO CONNECTION 12. CATHODE 13. CATHODE 14. NO CONNECTION 15. ANODE 16. CATHODE	STYLE 3: PIN 1. COLLECTOR, DYE #1 2. BASE, #1 3. EMITTER, #1 4. COLLECTOR, #1 5. COLLECTOR, #2 6. BASE, #2 7. EMITTER, #2 8. COLLECTOR, #2 9. COLLECTOR, #3 10. BASE, #3 11. EMITTER, #3 12. COLLECTOR, #3 13. COLLECTOR, #4 14. BASE, #4 15. EMITTER, #4 16. COLLECTOR, #4	STYLE 4: PIN 1. COLLECTOR, DYE #1 2. COLLECTOR, #1 3. COLLECTOR, #2 4. COLLECTOR, #2 5. COLLECTOR, #3 6. COLLECTOR, #3 7. COLLECTOR, #4 8. COLLECTOR, #4 9. BASE, #4 10. EMITTER, #4 11. BASE, #3 12. EMITTER, #3 13. BASE, #2 14. EMITTER, #2 15. BASE, #1 16. EMITTER, #1
STYLE 5: PIN 1. DRAIN, DYE #1 2. DRAIN, #1 3. DRAIN, #2 4. DRAIN, #2 5. DRAIN, #3 6. DRAIN, #3 7. DRAIN, #4 8. DRAIN, #4 9. GATE, #4 10. SOURCE, #4 11. GATE, #3 12. SOURCE, #3 13. GATE, #2 14. SOURCE, #2 15. GATE, #1 16. SOURCE, #1	STYLE 6: PIN 1. CATHODE 2. CATHODE 3. CATHODE 4. CATHODE 5. CATHODE 6. CATHODE 7. CATHODE 8. CATHODE 9. ANODE 10. ANODE 11. ANODE 12. ANODE 13. ANODE 14. ANODE 15. ANODE 16. ANODE	STYLE 7: PIN 1. SOURCE N-CH 2. COMMON DRAIN (OUTPUT) 3. COMMON DRAIN (OUTPUT) 4. GATE P-CH 5. COMMON DRAIN (OUTPUT) 6. COMMON DRAIN (OUTPUT) 7. COMMON DRAIN (OUTPUT) 8. SOURCE P-CH 9. SOURCE P-CH 10. COMMON DRAIN (OUTPUT) 11. COMMON DRAIN (OUTPUT) 12. COMMON DRAIN (OUTPUT) 13. GATE N-CH 14. COMMON DRAIN (OUTPUT) 15. COMMON DRAIN (OUTPUT) 16. SOURCE N-CH	

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